

TSV711, TSV712, TSV714

High accuracy (200 μV) micropower 14 μA, 150 kHz 5 V CMOS operational amplifiers



Features

- Low offset voltage: 200 μV max.
- Low power consumption: 10 µA at 5 V
- Low supply voltage: 1.5 V to 5.5 V
- Gain bandwidth product: 150 kHz typ.
- Low input bias current: 1 pA typ.
- Rail-to-rail input and output
- EMI hardened operational amplifiers
- High tolerance to ESD: 4 kV HBM
- Extended temperature range: -40 to +125 °C

Datasheet - preliminary data

Benefits

- Higher accuracy without calibration
- Energy saving
- Guaranteed operation on low-voltage battery

Related products

 See the TSV73 series (900 kHz for 60 μA) for higher gain bandwidth products

Applications

- Battery powered applications
- Portable devices
- Signal conditioning
- Active filtering
- Medical instrumentation

Description

The TSV71x series of single, dual, and quad operational amplifiers offer low-voltage operation, rail-to-rail input and output, and excellent accuracy (V_{io} lower than 200 μ V at 25 °C).

These devices benefit from STMicroelectronics[®] 5 V CMOS technology and offer an excellent speed/power consumption ratio (150 kHz typical gain bandwidth) while consuming less than 14 μ A at 5 V. The TSV71x series also feature an ultra-low input bias current.

The single version (TSV711), the dual version (TSV712), and the quad version (TSV714) are housed in the smallest industrial packages.

These characteristics make the TSV71x family ideal for sensor interfaces, battery-powered and portable applications, and active filtering.

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This is preliminary information on a new product now in development or undergoing evaluation. Details are subject to change without notice.

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1 Pin connections



1. The exposed pads of the QFN16 3x3 can be connected to VCC- or left floating.



2 Absolute maximum ratings and operating conditions

Symbol	Parameter	Value	Unit			
V _{CC}	Supply voltage ⁽¹⁾	6				
V _{id}	Differential input voltage ⁽²⁾	±V _{CC}	V			
V _{in}	Input voltage ⁽³⁾	V_{CC-} - 0.2 to V_{CC+} + 0.2	2			
l _{in}	Input current ⁽⁴⁾	10	mA			
T _{stg}	Storage temperature	-65 to +150	°C			
R _{thja}	Thermal resistance junction-to-ambient ⁽⁵⁾⁽⁶⁾ SC70-5 DFN8 2x2 MiniSO8 QFN16 3x3 TSSOP14	205 120 190 45 100	°C/W			
R _{thjc}	Thermal resistance junction-to-case DFN8 2x2	33				
Тj	Maximum junction temperature	150	°C			
	HBM: human body model ⁽⁷⁾	4	kV			
	MM: machine model for TSV711 ⁽⁸⁾	150				
	MM: machine model for TSV712 ⁽⁸⁾	200	V			
ESD	MM: machine model for TSV714 ⁽⁸⁾	300				
	CDM: charged device model except MiniSO8 ⁽⁹⁾	1.5				
	CDM: charged device model for MiniSO8 ⁽⁹⁾	1.3	kV			
	Latchup immunity	200	mA			

Table 1. Absolute n	naximum ratings	(AMR)
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1. All voltage values, except the differential voltage are with respect to the network ground terminal.

 The differential voltage is a non-inverting input terminal with respect to the inverting input terminal. The TSV712 and TSV714 devices include an internal differential voltage limiter that clamps internal differential voltage at 0.5 V.

- 3. V_{CC} V_{in} must not exceed 6 V, V_{in} must not exceed 6 V.
- 4. Input current must be limited by a resistor in series with the inputs.
- 5. Short-circuits can cause excessive heating and destructive dissipation.
- 6. R_{th} are typical values.
- 7. Human body model: 100 pF discharged through a 1.5 k Ω resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
- Machine model: a 200 pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω), done for all couples of pin combinations with other pins floating.
- 9. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to ground.



Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	1.5 to 5.5	V
V _{icm}	Common mode input voltage range	$V_{CC-} - 0.1$ to $V_{CC+} + 0.1$	v
T _{oper}	Operating free air temperature range	-40 to +125	°C

Table 2. Operating conditions



3 Electrical characteristics

Table 3. Electrical characteristics at V_{CC+} = 1.8 V with V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, and R_L = 10 k Ω connected to V_{CC}/2 (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
DC perfor	mance						
		T = 25 °C			200		
V _{io}	Input offset voltage (V _{icm} = 0 V)	-40 °C < T< 85 °C			850	μV	
		-40 °C < T< 125 °C			1200		
$\Delta V_{io} / \Delta T$	Input offset voltage drift	-40 °C < T< 125 °C ⁽¹⁾			10	μV/°C	
	Input offset current	T = 25 °C		1	10 ⁽²⁾		
I _{io}	$(V_{out} = V_{CC}/2)$	-40 °C < T< 125 °C		1	300 ⁽²⁾		
	$\int dn n u t higg a u root (1/2 - 1/2)$	T = 25 °C		1	10 ⁽²⁾	pА	
I _{ib}	Input bias current ($V_{out} = V_{CC}/2$)	-40 °C < T< 125 °C		1	300 ⁽²⁾		
	Common mode rejection ratio	T = 25 °C	69	88			
CMR	$MR = \begin{cases} 20 \log (\Delta V_{icm} / \Delta V_{io}) \\ V_{icm} = 0 \ V \ to \ V_{CC}, \\ V_{out} = V_{CC} / 2, \ R_L > 1 \ M\Omega \end{cases}$	-40 °C < T< 125 °C	61			dB	
٨	Large signal voltage gain	T = 25 °C	95				
A _{vd}	$V_{out} = 0.5 V \text{ to } (V_{CC} - 0.5 V)$	-40 °C < T< 125 °C	85				
M	High level output voltage	T = 25 °C			75		
V _{OH}	$(V_{OH} = V_{CC} - V_{out})$	-40 °C < T< 125 °C			80		
M		T = 25 °C			40	mV	
V _{OL}	Low level output voltage	-40 °C < T< 125 °C			60		
		T = 25 °C	6	12			
	I_{sink} (V _{out} = V _{CC})	-40 °C < T< 125 °C	4				
l _{out}		T = 25 °C	5	7		mA	
	$I_{source} (V_{out} = 0 V)$	-40 °C < T< 125 °C	3				
I	Supply current (per channel,	T = 25 °C		9	14		
I _{CC}	$V_{out} = V_{CC}/2, R_L > 1 M\Omega$	-40 °C < T< 125 °C			16	μA	



Table 3. Electrical characteristics at V_{CC+} = 1.8 V with V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, and R_L = 10 k Ω connected to V_{CC}/2 (unless otherwise specified) (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
AC perfor	mance					
GBP	Gain bandwidth product		100	120		
Fu	Unity gain frequency	 - R _I = 10 kΩ, C _I = 100 pF		100		kHz
$\Phi_{\rm m}$	Phase margin			45		Degrees
G _m	Gain margin			19		dB
SR	Slew rate ⁽³⁾	$ \begin{array}{l} {\sf R}_{\sf L} = 10 \; {\sf k}\Omega \ \ {\sf C}_{\sf L} = 100 \; {\sf pF}, \\ {\sf V}_{out} = 0.5 \; {\sf V} \; to \; {\sf V}_{\sf CC} - 0.5 \; {\sf V} \end{array} $		0.04		V/μs
		f = 1 kHz		100		nV
e _n	Equivalent input noise voltage	f = 10 kHz		96		<u>nV</u> √Hz
t _{init}	Initialization time ⁽⁴⁾	T = 25 °C			5	me
		-40 °C < T< 125 °C			60	ms

1. See Section 4.4: Input offset voltage drift over temperature.

2. Guaranteed by characterization.

3. Slew rate value is calculated as the average between positive and negative slew rates.

4. Initialization time is defined as the delay after power-up to guarantee operation within specified performances. Guaranteed by design. See Section 4.6: Initialization time.



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
DC perfor	mance					
		T = 25 °C			200	
V _{io}	Input offset voltage	-40 °C < T< 85 °C			850	μV
		-40 °C < T< 125 °C			1200	
$\Delta V_{io} / \Delta T$	Input offset voltage drift	-40 °C < T< 125 °C ⁽¹⁾			10	μV/°C
ΔV_{io}	Long-term input offset voltage drift	T = 25 °C ⁽²⁾		0.3		$\frac{\mu V}{\sqrt{month}}$
	I_{io} Input offset current (V _{out} = V _{CC} /2)	T = 25 °C		1	10 ⁽³⁾	
l _{io}		-40 °C < T< 125 °C		1	300 ⁽³⁾	
		T = 25 °C		1	10 ⁽³⁾ pA	
l _{ib}	Input bias current ($V_{out} = V_{CC}/2$)	-40 °C < T< 125 °C		1	300 ⁽³⁾	
Common mode rejection ratio	T = 25 °C	80	100			
CMR	$ \begin{array}{l} 20 \log \left(\Delta V_{icm} / \Delta V_{io} \right) \\ V_{icm} = 0 \; V \; to \; V_{CC}, \; V_{out} = V_{CC} / 2, \\ R_L > 1 \; M \Omega \end{array} $	-40 °C < T< 125 °C	69			dB
•	Large signal voltage gain	T = 25 °C	95			
A _{vd}	$V_{out} = 0.5 V \text{ to } (V_{CC} - 0.5 V)$	-40 °C < T< 125 °C	85			
	High level output voltage	T = 25 °C			75	
V _{OH}	$(V_{OH} = V_{CC} - V_{out})$	-40 °C < T< 125 °C			80	
) (T = 25 °C			40	mV
V _{OL}	Low level output voltage	-40 °C < T< 125 °C			60	
		T = 25 °C	20	34		
	I_{sink} (V _{out} = V _{CC})	-40 °C < T< 125 °C	15			
l _{out}		T = 25 °C	20	26	1	mA
	$I_{\text{source}} (V_{\text{out}} = 0 \text{ V})$	-40 °C < T< 125 °C	15]
	Supply current (per channel,	T = 25 °C		9	14	
I _{CC}	$V_{out} = V_{CC}/2, R_L > 1 M\Omega$	-40 °C < T< 125 °C			16	μA

Table 4. Electrical characteristics at V_{CC+} = 3.3 V with V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, and R_L = 10 k Ω connected to V_{CC}/2 (unless otherwise specified)



Table 4. Electrical characteristics at V_{CC+} = 3.3 V with V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, and R_L = 10 k Ω connected to V_{CC}/2 (unless otherwise specified) (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
AC perfor	mance					
GBP	Gain bandwidth product		100	120		
Fu	Unity gain frequency	R _I = 10 kΩ C _I = 100 pF		100		kHz
$\Phi_{\rm m}$	Phase margin	$R_{L} = 10 \text{ ksz} C_{L} = 100 \text{ pr}$		45		Degrees
G _m	Gain margin			19		dB
SR	Slew rate ⁽⁴⁾			0.05		V/μs
0	Equivalant input poise voltage	f = 1 kHz		100		nV
e _n	Equivalent input noise voltage	f = 10 kHz		96		<u>nV</u> √Hz
t _{init}	Initialization time ⁽⁵⁾	T = 25 °C			5	
		-40 °C < T< 125 °C			50	ms

1. See Section 4.4: Input offset voltage drift over temperature.

 Typical value is based on the V_{io} drift observed after 1000h at 125 °C extrapolated to 25 °C using the Arrhenius law and assuming an activation energy of 0.7 eV. The operational amplifier is aged in follower mode configuration. See <u>Section 4.5</u>: Long-term input offset voltage drift.

3. Guaranteed by characterization.

4. Slew rate value is calculated as the average between positive and negative slew rates.

5. Initialization time is defined as the delay after power-up which guarantees operation within specified performances. Guaranteed by design. See *Section 4.6: Initialization time*.



Table 5. Electrical characteristics at $V_{CC+} = 5 V$ with $V_{CC-} = 0 V$, $V_{icm} = V_{CC}/2$, T = 25 °C,	
and R _L = 10 k Ω connected to V _{CC} /2 (unless otherwise specified)	

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
DC perfor	mance			•	•	
		T = 25 °C			200	
V _{io}	Input offset voltage	-40 °C < T< 85 °C			850	μV
		-40 °C < T< 125 °C			1200	
$\Delta V_{io} / \Delta T$	Input offset voltage drift	-40 °C < T< 125 °C ⁽¹⁾			10	μV/°C
ΔV_{io}	Long-term input offset voltage drift	T = 25 °C ⁽²⁾		0.7		$\frac{\mu V}{\sqrt{month}}$
	Input offset current	T = 25 °C		1	10 ⁽³⁾	
l _{io}	$(V_{out} = V_{CC}/2)$	-40 °C < T< 125 °C		1	300 ⁽³⁾	-
	Input bias current	T = 25 °C		1	10 ⁽³⁾	рА
l _{ib}	$(V_{out} = V_{CC}/2)$	-40 °C < T< 125 °C		1	300 ⁽³⁾	
	Common mode rejection ratio	T = 25 °C	74	94		
CMR	$\begin{array}{l} 20 \mbox{ log } (\Delta V_{icm}/\Delta V_{io}) \\ V_{icm} = 0 \mbox{ V to } V_{CC}, \\ V_{out} = V_{CC}/2, \mbox{ R}_L > 1 \mbox{ M}\Omega \end{array}$	-40 °C < T< 125 °C	73			
	$SVR \begin{cases} Supply voltage rejection ratio \\ 20 log (\Delta V_{CC}/\Delta V_{io}) \\ V_{CC} = 1.5 to 5.5 V, V_{ic} = 0 V, \\ R_L > 1 M\Omega \end{cases}$	T = 25 °C	71	90		
SVR		-40 °C < T< 125 °C	71			
٨	Large signal voltage gain	T = 25 °C	95			dB
A _{vd}	$V_{out} = 0.5 V \text{ to } (V_{CC} - 0.5 V)$	-40 °C < T< 125 °C	85			
		V _{RF} = 100 mV _{RFpeak,} f = 400 MHz		38 ⁽⁴⁾		
EMIRR	EMI rejection ratio	V _{RF} = 100 mV _{RFpeak,} f = 900 MHz		50 ⁽⁴⁾		
	EMIRR = 20 log (V _{RFpeak} / Δ V _{io})	V _{RF} = 100 mV _{RFpeak} , f = 1800 MHz		60 ⁽⁴⁾		
		V_{RF} = 100 m V_{RFpeak} , f = 2400 MHz		63 ⁽⁴⁾		
V _{OH}	High level output voltage	T = 25 °C			75	
VОН	$(V_{OH} = V_{CC} - V_{out})$	-40 °C < T< 125 °C			80	mV
V _{OL}	Low level output voltage	T = 25 °C			40	IIIV
VOL	Low level output voltage	-40 °C < T< 125 °C			60	
	$ \cdot \cdot \cdot \rangle / \cdot = \rangle / = 0$	T = 25 °C	35	56		
L	I _{sink (} V _{out} = V _{CC)}	-40 °C < T< 125 °C	20			mA
l _{out}	I _{source} (V _{out} = 0 V)	T = 25 °C	35	45		
	source (vout - 0 v)	-40 °C < T< 125 °C	20			
	Supply current (per channel,	T = 25 °C		10	14	μA
I _{CC}	$V_{out} = V_{CC}/2, R_L > 1 M\Omega$	-40 °C < T< 125 °C			16	



Table 5. Electrical characteristics at V_{CC+} = 5 V with V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, and R_L = 10 k Ω connected to V_{CC}/2 (unless otherwise specified) (continued)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
AC perfor	mance		•	•			
GBP	Gain bandwidth product		110	150			
Fu	Unity gain frequency	$P = 10 k_0 C = 100 pE$		120		kHz	
Φ_{m}	Phase margin	R _L = 10 kΩ, C _L = 100 pF		45		Degrees	
G _m	Gain margin			19		dB	
SR	Slew rate ⁽⁵⁾	$R_L = 10 \text{ k}\Omega, C_L = 100 \text{ pF},$ $V_{out} = 0.5 \text{ V to } V_{CC} - 0.5 \text{ V}$		0.06		V/μs	
∫ e _n	Low-frequency peak-to-peak input noise	Bandwidth: f = 0.1 to 10 Hz		10		μV _{pp}	
		f = 1 kHz		100		n\/	
e _n	Equivalent input noise voltage	f = 10 kHz		96		<u>nV</u> √Hz	
THD+N	Total harmonic distortion + noise			0.008		%	
+	Initialization time ⁽⁶⁾	T = 25 °C			5	me	
t _{init}		-40 °C < T< 125 °C			50	ms	

1. See Section 4.4: Input offset voltage drift over temperature.

 Typical value is based on the V_{io} drift observed after 1000h at 125 °C extrapolated to 25 °C using the Arrhenius law and assuming an activation energy of 0.7 eV. The operational amplifier is aged in follower mode configuration. See <u>Section 4.5</u>: Long-term input offset voltage drift.

3. Guaranteed by characterization.

4. Tested on SC70-5 package.

5. Slew rate value is calculated as the average between positive and negative slew rates.

6. Initialization time is defined as the delay after power-up to guarantee operation within specified performances. Guaranteed by design. See Section 4.6: Initialization time.





Figure 4. Input offset voltage distribution at $V_{CC} = 3.3 V$, $V_{icm} = V_{CC}/2$



Figure 6. Input offset voltage vs. input common mode voltage

T = 25 °C

T = -40 °C



TSV711, TSV712, TSV714



Figure 5. Input offset voltage temperature coefficient distribution



Figure 7. Input offset voltage vs. temperature



 $V_{CC} = 5 V$ 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0 Input common mode voltage (V)



500 400

300

200

100 0.0

-100 -200 Input

-300

-400

-500

0.0 0.5 1.0

offset voltage (µV)

T = 125 °C





Figure 8. Output current vs. output voltage at V_{CC} = 1.5 V





Figure 10. Output current vs. supply voltage



Figure 12. Bode diagram at V_{CC} = 5 V

Figure 11. Bode diagram at V_{CC} = 1.5 V



Figure 13. Closed-loop gain diagram vs. capacitive load







Figure 15. Negative slew rate



Figure 16. Slew rate vs. supply voltage



Figure 18. 0.1 Hz to 10 Hz noise



Figure 19. THD+N vs. frequency

Figure 17. Noise vs. frequency





Figure 20. THD+N vs. output voltage

Figure 21. Output impedance vs. frequency in closed-loop configuration





4 Application information

4.1 Operating voltages

The TSV71x series of devices can operate from 1.5 V to 5.5 V. The parameters are fully specified for 1.8 V, 3.3 V, and 5 V power supplies. However, they are very stable in the full V_{CC} range and several characterization curves show TSV71x device characteristics at 1.5 V. In addition, the main specifications are guaranteed in the extended temperature range from -40 °C to +125 °C.

4.2 Rail-to-rail input

The TSV711, TSV712, and TSV714 devices have a rail-to-rail input, and the input common mode range is extended from V_{CC-}- 0.1 V to V_{CC+} + 0.1 V.

4.3 Rail-to-rail output

The output levels of the TSV71x operational amplifiers can go close to the rails: to a maximum of 40 mV below the upper rail and to a maximum of 75 mV above the lower rail when a 10 k Ω resistive load is connected to V_{CC}/2.

4.4 Input offset voltage drift over temperature

The maximum input voltage drift over the temperature variation is defined as the offset variation related to offset value measured at 25 °C. The operational amplifier is one of the main circuits of the signal conditioning chain, and the amplifier input offset is a major contributor to the chain accuracy. The signal chain accuracy at 25 °C can be compensated during production at application level. The maximum input voltage drift over temperature enables the system designer to anticipate the effect of temperature variations.

The maximum input voltage drift over temperature is computed using *Equation 1*.

Equation 1

$$\frac{\Delta V_{io}}{\Delta T} = \max \left| \frac{V_{io}(T) - V_{io}(25^{\circ} C)}{T - 25^{\circ} C} \right|$$

with T = -40 °C and 125 °C.

The datasheet maximum value is guaranteed by a measurement on a representative sample size ensuring a C_{pk} (process capability index) greater than 1.33.



4.5 Long-term input offset voltage drift

To evaluate product reliability, two types of stress acceleration are used:

- Voltage acceleration, by changing the applied voltage
- Temperature acceleration, by changing the die temperature (below the maximum junction temperature allowed by the technology) with the ambient temperature.

The voltage acceleration has been defined based on JEDEC results, and is defined using *Equation 2*.

Equation 2

$$A_{FV} = e^{\beta \cdot (V_S - V_U)}$$

Where:

A_{FV} is the voltage acceleration factor

 β is the voltage acceleration constant in 1/V, constant technology parameter (β = 1)

 V_S is the stress voltage used for the accelerated test

V_U is the voltage used for the application

The temperature acceleration is driven by the Arrhenius model, and is defined in *Equation 3*.

Equation 3

$$A_{FT} = e^{\frac{E_a}{k} \cdot \left(\frac{1}{T_U} - \frac{1}{T_S}\right)}$$

Where:

A_{FT} is the temperature acceleration factor

E_a is the activation energy of the technology based on the failure rate

k is the Boltzmann constant (8.6173 x 10^{-5} eV.K⁻¹)

 T_U is the temperature of the die when V_U is used (K)

 T_S is the temperature of the die under temperature stress (K)

The final acceleration factor, A_{F} , is the multiplication of the voltage acceleration factor and the temperature acceleration factor (*Equation 4*).

Equation 4

 $A_F = A_{FT} \times A_{FV}$

 A_F is calculated using the temperature and voltage defined in the mission profile of the product. The A_F value can then be used in *Equation 5* to calculate the number of months of use equivalent to 1000 hours of reliable stress duration.



Equation 5

Months = $A_F \times 1000 \text{ h} \times 12 \text{ months} / (24 \text{ h} \times 365.25 \text{ days})$

To evaluate the op-amp reliability, a follower stress condition is used where V_{CC} is defined as a function of the maximum operating voltage and the absolute maximum rating (as recommended by JEDEC rules).

The V_{io} drift (in μ V) of the product after 1000 h of stress is tracked with parameters at different measurement conditions (see *Equation 6*).

Equation 6

 $V_{CC} = maxV_{op}$ with $V_{icm} = V_{CC}/2$

The long term drift parameter (ΔV_{io}), estimating the reliability performance of the product, is obtained using the ratio of the V_{io} (input offset voltage value) drift over the square root of the calculated number of months (*Equation 7*).

Equation 7

$$\Delta V_{io} = \frac{V_{io} drift}{\sqrt{(months)}}$$

where $V_{io}^{}\ drift$ is the measured drift value in the specified test conditions after 1000 h stress duration.



4.6 Initialization time

The TSV71x series of devices use a proprietary trimming topology that is initiated at each device power-up and allows excellent V_{io} performance to be achieved. The initialization time is defined as the delay after power-up which guarantees operation within specified performances. During this period, the current consumption (I_{CC}) and the input offset voltage (V_{io}) can be different to the typical ones.



Figure 22. Initialization phase

The initialization time is V_{CC} and temperature dependent. *Table 6* sums up the measurement results for different supply voltages and for temperatures varying from -40 °C to 125 °C.

Table 6.	Initialization	time	measurement results
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	Temperature: -40 °C		Temperature: 25 °C		Temperature: 125 °C	
V _{CC} (V)	T _{init} (ms)	I _{CC} phase 1 (mA)	T _{init} (ms)	I _{CC} phase 1 (mA)	T _{init} (ms)	I _{CC} phase 1 (mA)
1.8	37	0.33	3.2	0.40	0.35	0.46
3.3	2.9	1.4	0.95	1.3	0.34	1.2
5	2.4	3.2	0.85	2.4	0.31	2.9

4.7 PCB layouts

For correct operation, it is advised to add a 10 nF decoupling capacitors as close as possible to the power supply pins.



4.8 Macromodel

Accurate macromodels of the TSV71x devices are available on the STMicroelectronics' website at www.st.com. These model are a trade-off between accuracy and complexity (that is, time simulation) of the TSV71x operational amplifiers. They emulate the nominal performance of a typical device within the specified operating conditions mentioned in the datasheet. They also help to validate a design approach and to select the right operational amplifier, *but they do not replace on-board measurements*.



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



5.1 SC70-5 package information



Figure 23. SC70-5 package mechanical drawing

Table 7. SC70-5 package mechanical data

	Dimensions						
Symbol	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.80		1.10	0.032		0.043	
A1	0		0.10			0.004	
A2	0.80	0.90	1.00	0.032	0.035	0.039	
b	0.15		0.30	0.006		0.012	
с	0.10		0.22	0.004		0.009	
D	1.80	2.00	2.20	0.071	0.079	0.087	
E	1.80	2.10	2.40	0.071	0.083	0.094	
E1	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65			0.025		
e1		1.30			0.051		
L	0.26	0.36	0.46	0.010	0.014	0.018	
<	0°		8°	0°		8°	



5.2 DFN8 2x2 package information



Figure 24. DFN8 2x2 package mechanical drawing

Table 8. DFN8 2x2 package mechanical data

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.15	0.20	0.25	0.006	0.008	0.010	
D		2.00			0.079		
E		2.00			0.079		
е		0.50			0.020		
L	0.045	0.55	0.65	0.018	0.022	0.026	
N	8				8		



5.3 MiniSO-8 package information



Figure 25. MiniSO-8 package mechanical drawing

Table 9. MiniSO-8 package mechanical data

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.1			0.043	
A1	0		0.15	0		0.006	
A2	0.75	0.85	0.95	0.030	0.033	0.037	
b	0.22		0.40	0.009		0.016	
С	0.08		0.23	0.003		0.009	
D	2.80	3.00	3.20	0.11	0.118	0.126	
E	4.65	4.90	5.15	0.183	0.193	0.203	
E1	2.80	3.00	3.10	0.11	0.118	0.122	
е		0.65			0.026		
L	0.40	0.60	0.80	0.016	0.024	0.031	
L1		0.95			0.037		
L2		0.25			0.010		
k	0 °		8 °	0 °		8 °	
CCC			0.10			0.004	



5.4 QFN16 3x3 package information



Figure 26. QFN16 3x3 package mechanical drawing



Table To. QFN To 5x5 min package mechanical data (pitch 0.5 min)						,	
	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.80	0.90	1.00	0.031	0.035	0.039	
A1	0		0.05	0		0.002	
A3		0.20			0.008		
b	0.18		0.30	0.007		0.012	
D	2.90	3.00	3.10	0.114	0.118	0.122	
D2	1.50		1.80	0.059		0.071	
E	2.90	3.00	3.10	0.114	0.118	0.122	
E2	1.50		1.80	0.059		0.071	
е		0.50			0.020		
L	0.30		0.50	0.012		0.020	

Table 10. QFN16 3x3 mm package mechanical data (pitch 0.5 mm)





5.5 TSSOP14 package information



Figure 28. TSSOP14 package mechanical drawing

Table 11. TSSOP14 package mechanical data

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.20			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.80	1.00	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
с	0.09		0.20	0.004		0.0089	
D	4.90	5.00	5.10	0.193	0.197	0.201	
E	6.20	6.40	6.60	0.244	0.252	0.260	
E1	4.30	4.40	4.50	0.169	0.173	0.176	
е		0.65			0.0256		
L	0.45	0.60	0.75	0.018	0.024	0.030	
L1		1.00			0.039		
k	0 °		8 °	0 °		8 °	
ааа			0.10			0.004	



6 Ordering information

Order code	Temperature range	Package	Packaging	Marking
TSV711ICT		SC70-5		K1W
TSV712IQ2T		DFN8 2x2		K1W
TSV712IST	-40° C to +125° C	MiniSO8	Tape and reel	V712
TSV714IQ4T		QFN16 3x3		K1W
TSV714IPT		TSSOP14		TSV714IP

Table 12. Order codes

7 Revision history

Date Revision		Changes
26-Sep-2012	1	Initial internal release
		Initial public release.
		Datasheet updated for two new products: TSV712 and TSV714.
26-Mar-2013	2	Four new packages added: DFN8 2x2, MiniSO-8, QFN16 3x3, and TSSOP14.
		Updated Table 3, Table 4, and Table 5.
		Section 4: Application information: re-written

Table 13. Document revision history



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